

VS3640DP-VB Datasheet

Dual N-Channel 30 V (D-S) MOSFET

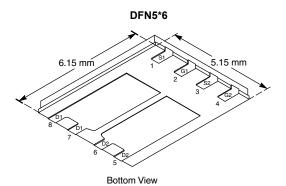
PRODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)		
30	0.018 at V _{GS} = 10 V	22		

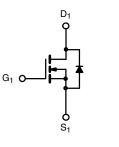
FEATURES

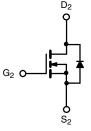
- Halogen-free According to IEC 61249-2-21
 Definition
- Trench Power MOSFET
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



COMPLIANT HALOGEN FREE Available







N-Channel MOSFET

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)						
Parameter		Symbol	10 s	Steady State	Unit	
Drain-Source Voltage		V _{DS}	30		V	
Gate-Source Voltage		V _{GS}	± 20			
Continuous Drain Current $(T_1 = 150 \text{ °C})^a$	T _A = 25 °C	1-	22		А	
Continuous Drain Current (1) = 150°C)	T _A = 70 °C	I _D	15			
Pulsed Drain Current		I _{DM}	50		A	
Continuous Source Current (Diode Conduction) ^a		۱ _S	2.9			
Maximum Power Dissipation ^a	T _A = 25 °C	P	3.5		W	
	T _A = 70 °C	P _D	2.2		vv	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55	to 150	0°	
Soldering Recommendations (Peak Temperature)			2	60	C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
	$t \le 10 s$	R _{thJA}	26	35	°C/W
Maximum Junction-to-Ambient ^a	Steady State		60	85	
Maximum Junction-to-Case (Drain)	Steady State	R _{thJC}	3.9	5.5	

Notes:

a. Surface mounted on 1" x 1" FR4 board.

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
Parameter	Symbol	Test Conditions Min.		Тур.	Max.	Unit
Static	. <u> </u>					
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.8		2.4	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 V$, $V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	1	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		1		
Zero Gale Voltage Drain Current	I _{DSS}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$		5	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, $V_{GS} = 10$ V	20			А
Drain-Source On-State Resistance ^a	Р	V _{GS} = 10 V, I _D = 10 A		0.018		Ω
	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 8.5 \text{ A}$		0.024		
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		22		S
Diode Forward Voltage ^a	V _{SD}	I _S = 2.9 A, V _{GS} = 0 V		0.75	1.2	V
Dynamic ^b						
Total Gate Charge	Qg			13	20	
Gate-Source Charge	Q _{gs}	$V_{DS} = 15 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 10 \text{ A}$		2		nC
Gate-Drain Charge	Q _{gd}			2.7		
Gate Resistance	Rg		0.5		3.2	Ω
Turn-On Delay Time	t _{d(on)}			8	16	
Rise Time	t _r	$V_{DD} = 15 \text{ V}, \text{ R}_{L} = 15 \Omega$		10	20	
Turn-Off Delay Time	t _{d(off)}	$\text{I}_\text{D}\cong$ 1 A, V_GEN = 10 V, R_g = 6 Ω		21	40	ns
Fall Time	t _f			10	20	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 2.9 A, dl/dt = 100 A/μs		40	80	

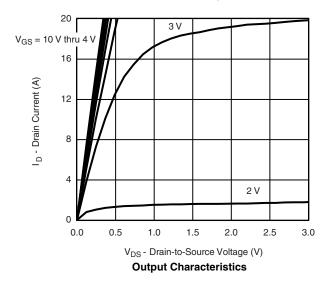
Notes:

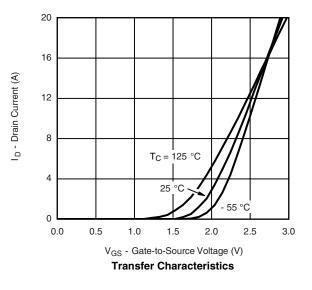
a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

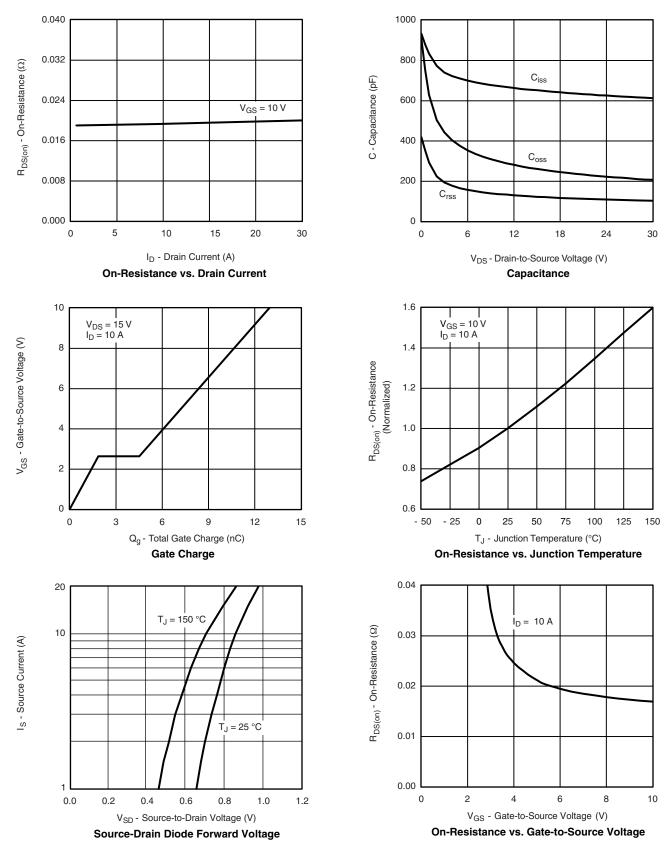
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





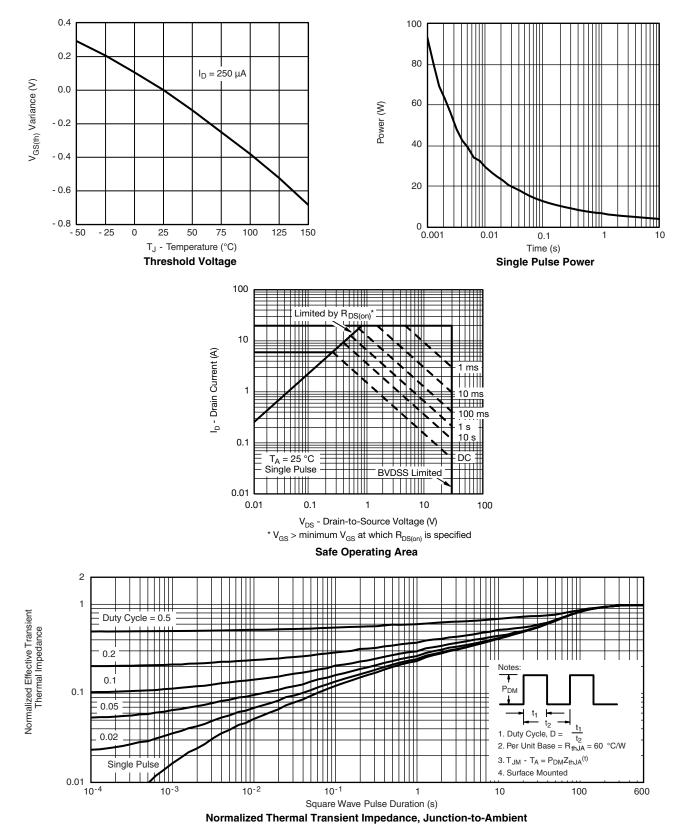






服务热线:400-655-8788

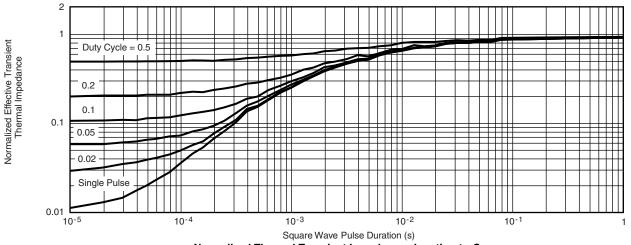




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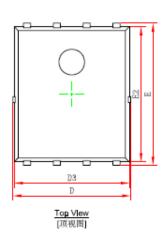
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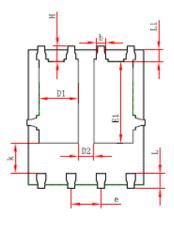


Normalized Thermal Transient Impedance, Junction-to-Case

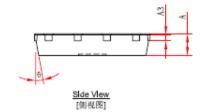


PDFNWB5×6-8L-A PACKAGE OUTLINE DIMENSIONS





<u>Bottom Vlew</u> [背视图]



Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
A	0.900	1.000	0.035	0.039	
A3	0.254 REF.		0.010REF.		
D	4.944	5.096	0.195	0.201	
E	5.974	6.126	0.235	0.241	
D1	1.470	1.870	0.058	0.074	
D2	0.470	0.870	0.019	0.034	
E1	3.375	3.575	0.133	0.141	
D3	4.824	4.976	0.190	0.196	
E2	5.674	5.826	0.223	0.229	
k	1.190	1.390	0.047	0.055	
b	0.350	0.450	0.014	0.018	
e	1.270TYP.		0.050TYP.		
L	0.559	0.711	0.022	0.028	
L1	0.424	0.576	0.017	0.023	
Н	0.574	0.726	0.023	0.029	
θ	10°	12°	10°	12°	



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